SOP8-P-1.27A

Weight: 0.08 g (typ.)

Toshiba Intelligent Power Device Silicon Monolithic Power MOS Integrated Circuit

TPD1032F

2-IN-1 Low-Side Power Switch for Motor, Solenoid and Lamp Drive

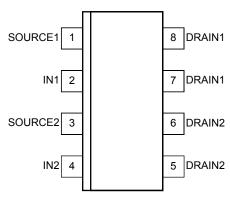
The TPD1032F is a 2-IN-1 low-side switch.

The IC has a vertical MOSFET output which can be directly driven from a CMOS or TTL logic circuit (e.g., an MPU). The IC is equipped with intelligent self-protection functions.

Features

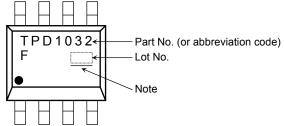
- Two built-in power IC chips with a new structure combining a control block and a vertical power MOSFET (L2- π -MOS) on each chip.
- Can directly drive a power load from a CMOS or TTL logic.
- Built-in protection circuits against overvoltage (active clamp), overtemperature (thermal shutdown), and overcurrent (current limiter).
- Low Drain-Source ON-resistance: Rps (on) = 0.4Ω (max) (@VIN = 5 V, ID = 1 A, T_{ch} = 25°C)
- Low Leakage Current: $I_{DSS} = 10 \mu A \text{ (max) (@V_{IN} = 0 V, V_{DS} = 20 V, T_{ch} = 25^{\circ}C)}$
- Low Input Current: $I_{IN} = 300 \mu A \text{ (max)} \text{ (@V}_{IN} = 5 \text{ V, } T_{ch} = -40 \sim 110 \text{°C})$
- 8-pin SOP package for surface with embossed-tape packing.

Pin Assignment (top view)



Due to its MOS structure, this product is sensitive to static electricity.

Marking



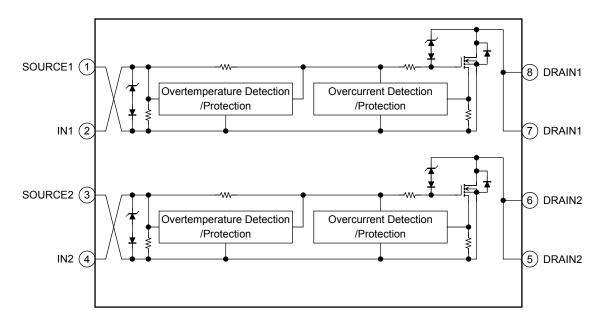
Note: A line under a Lot No. identifies the indication of product Labels. Not underlined: [[Pb]]/INCLUDES > MCV

Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. The RoHS is Directive 2011/65/EU of the European Parliament and of the Council of 8 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

> Start of commercial production 1999-10

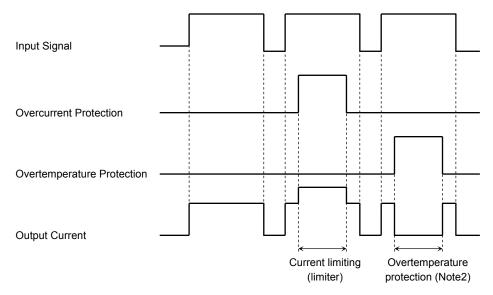
Block Diagram



Pin Description

Pin No.	Symbol	Pin Description			
1	SOURCE1	Source pin 1			
	IN1	Input pin 1			
2		This pin is connected to a pull-down resistor internally, so that even when input wiring is open-circuited, output can never be turned on inadvertently.			
3	SOURCE2	ource pin 2			
	IN2	Input pin 2			
4		This pin is connected to a pull-down resistor internally, so that even when input wiring is open-circuited, output can never be turned on inadvertently.			
F 6	DRAIN2	Drain pin 2			
5, 6		Drain current is limited (by current limiter) if it exceeds 3 A (min) in order to protect the IC.			
7 0	DRAIN1	Drain pin 1			
7, 8		Drain current is limited (by current limiter) if it exceeds 3 A (min) in order to protect the IC.			

Timing Chart



Note2: The overheating detector circuits feature hysteresis. After overheating is detected, normal operation is restored only when the channel temperature falls by the hysteresis amount (5°C typ.) in relation to the overheating detection temperature.

Truth Table

IN	V _{OUT}	Mode
L	Н	Normal
Н	L	Nomial
L	Н	Overcurrent
Н	Н	Overcurrent
L	Н	Overtemperature
Н	Н	Overtemperature

Absolute Maximum Ratings (Ta = 25°C)

	Characteristics			Rating	Unit	
Drain agurag voltaga		DC	V	20	V	
Drain-source voltage		Pulse	V_{DS}	40	V	
Drain current	I _D Internally limited			Α		
Input voltage			V _{IN}	–0.3 to 7	V	
Power dissipation	Sin	gle-device operation (Note4a)	P _{D(1)}	0.95		
(Ta=25°C)(Note 3a)		gle-device value at dual eration (Note4b)	P _{D(2)} 0.54 W			
Power dissipation	Sin	gle-device operation (Note4a)	P _{D(3)}	0.38	VV	
(Ta=25°C)(Note 3b)		gle-device value at dual eration (Note4b)	P _{D(4)}	40 Internally limited A -0.3 to 7 V 0.95 0.54 0.38 0.20 90 mJ 3 A 54 μ α -40 to 110 °C 150 °C		
Single pulse active clamp capability (Note 5)			E _{AS}	90	mJ	
Active clamp current	Active clamp current			3	Α	
Repetitive active clamp capability (Note 6)			E _{AR}	54	μJ	
Operating temperature			T _{opr}	-40 to 110	°C	
Channel temperature			T _{ch}	150	°C	
Storage temperature			T _{stg}	-55 to 150	°C	

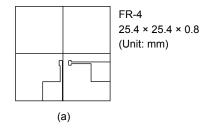
Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

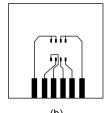
Thermal Characteristics

C	Symbol	Max	Unit		
Thermal resistance, to ambient	channel (Note3a)	Single-device operation (Note 4a)	R _{th (ch-a)(1)}	132 °C/W	
		Single-device value at dual operation (Note 4b)	R _{th (ch-a)(2)}	231	C/VV
Thermal resistance, to ambient	channel (Note3b)	Single-device operation (Note 4a)	R _{th (ch-a)(1)}	330	°C/W
		Single-device value at dual operation (Note 4b)	R _{th (ch-a)(2)}	625	C/VV

Note 3:



a) Device mounted on a glass-epoxy board (a)



25.4 × 25.4 × 0.8 (Unit: mm)

b) Device mounted on a glass-epoxy board (b)

Note 4:

a) The power dissipation and thermal resistance values are shown for a single device. (During single-device operation, power is only applied to one device.)

b) The power dissipation and thermal resistance values are shown for a single device. (During dual operation, power is evenly applied to both device.)

Note 5: Active clamp capability (single pulse) test condition

 $V_{DD} = 25$ V, Starting $T_{ch} = 25^{\circ}C,\, L = 10$ mH, $I_{AR} = 3$ A, $R_{G} = 25~\Omega$

Note 6: Repetitive rating, pulse width limited by maximum channel temperature.

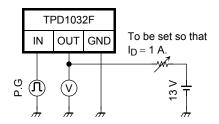
Electrical Characteristics

Characteristics	Symbol	Test Circuit	Test Condition		Min	Тур.	Max	Unit
Drain-source clamp voltage	V _{(CL) DSS}	_	T _{ch} =-40~110°C	V _{IN} = 0 V, I _D =1mA	40	_	60	V
Input threshold voltage	V _{th}		T _{ch} =25°C	V _{DS} = 13 V, I _D =10mA	1.0	_	2.8	V
		_	T _{ch} =-40~110°C		0.9	_	3.0	
Protective circuit operation	V		T _{ch} =25°C	_	3	_	7	· v
input voltage range	V _{IN} (opr)		T _{ch} =-40~110°C	_	3.5	_	7	
Drain cut-off current	IDSS		T _{ch} =25°C	V _{IN} = 0 V, V _{DS} =20V		_	10	μА
			T _{ch} =-40~110°C			_	100	
Input current	I _{IN (1)}	_	T _{ch} =25°C	V _{IN} = 5 V, at normal operation	_	_	300	μА
	I _{IN (2)}	_	T _{ch} =-40~110°C	V _{IN} = 5 V, when overcurrent protective circuit is actuated	_	_	350	
Drain-source on resistance	R _{DS} (ON)		T _{ch} =25°C	V _{IN} = 5 V, I _D = 1 A		0.25	0.4	Ω
Dialii-source on resistance			T _{ch} =-40~110°C			_	0.6	
Overtemperature protection	T _S	1	_	V _{IN} = 5 V	150	160		°C
Overcurrent protection	IS		T _{ch} =25°C	V _{IN} = 5 V	3	3.7	_	A
Overcurrent protection			T _{ch} =-40~110°C		2	_	_	
	ton		T _{ch} =25°C	V _{DD} = 13 V, V _{IN} = 0V/5 V, I _D = 1 A	_	_	30	- μ s
Switching time		1	T _{ch} =-40~110°C			_	60	
Switching time	t _{OFF}	'	T _{ch} =25°C		_	_	60	
			T _{ch} =-40~110°C		_	_	90	
Source-drain diode forward voltage	V _{DSF}	_	T _{ch} =25°C	I _F = 3 A, V _{IN} = 0 V	_	_	1.7	V

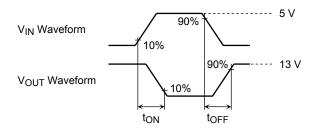
Test Circuit 1

Switching time measuring circuit

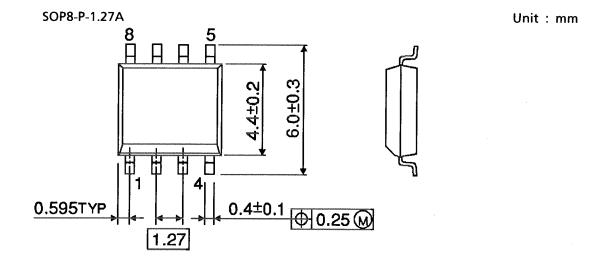
Test Circuit

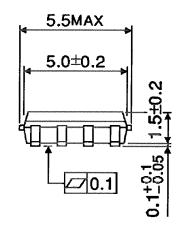


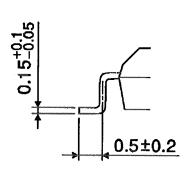
Measured Waveforms



Package Dimensions







Weight: 0.08 g (typ.)

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